

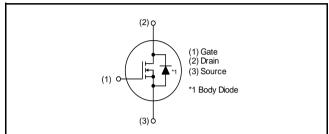
N-channel SiC power MOSFET bare die

V_{DSS}	750V
R _{DS(on)} (Typ.)	45mΩ
I _D ^{*1}	34A

Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive

●Inner circuit



Application

- Solar inverters
- DC/DC converters
- · Switch mode power supplies
- · Induction heating
- Motor drives

● Absolute maximum ratings (T_{vj} = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit	
Drain - source voltage		$V_{ extsf{DSS}}$	750	V	
Continuous drain and	V V	$T_c = 25^{\circ}C$	I _D , I _S *1	34	А
source current	$V_{GS} = V_{GS_on}$	$T_c = 100$ °C	I _D , I _S	24	А
Pulsed drain current	$V_{GS} = V_{GS_on}$	$T_c = 25^{\circ}C$	I _{D,pulse} *2	61	Α
Body diode pulsed forward current		$V_{GS} = 0 V$	*1,*3 S,pulse	34	А
Body diode surge forward current		$T_c = 25^{\circ}C$	I _{S,pulse} *1,*4	61	Α
Gate - source voltage (DC)		V_{GSS}	-4 to +21	V	
Gate - source surge voltage (t _{surge} < 300ns)		V _{GSS_surge} *5	-4 to +23	V	
Recommended turn-on gate - source drive voltage			$V_{GS_on}^{^{*6}}$	+15 to +18	V
Recommended turn-off gate - source drive voltage		V_{GS_off}	0	V	
Virtual junction temperature		$T_{v_{j}}$	175	°C	
Range of storage temperature		T_{stg}	-40 to +175	°C	

ullet Electrical characteristics ($T_{vj} = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Conditions		Unit		
raiailletei			Min.	Тур.	Max.	Offic
Drain - Source breakdown	V	$V_{GS} = 0 \text{ V}, I_{D} = 5.3 \text{mA}$				V
voltage	V (BR)DSS	$T_{vj} = 25^{\circ}C$	750	-	-	V
_		$V_{GS} = 0 \text{ V}, V_{DS} = 750 \text{V}$				
Zero Gate voltage Drain current	I _{DSS}	$T_{vj} = 25^{\circ}C$	-	1	80	μΑ
		T _{vj} = 150°C	-	10	-	
Gate - Source leakage current	I _{GSS+}	$V_{GS} = +21V$, $V_{DS} = 0V$	1	ı	100	nA
Gate - Source leakage current	I _{GSS-}	$V_{GS} = -4V$, $V_{DS} = 0V$	-	-	-100	nA
Gate threshold voltage	$V_{GS (th)}^{*7}$	$V_{DS} = 10V, I_{D} = 8.89 \text{mA}$	2.8	ı	4.8	V
		$V_{GS} = 18V, I_{D} = 17A$				
Static Drain - Source on - state resistance	R _{DS(on)} *8	$T_{vj} = 25^{\circ}C$	-	45	57	mΩ
		T _{vj} = 150°C	-	77	-	
Gate input resistance	R_{G}	f = 1MHz, open drain	-	4	-	Ω

ullet Electrical characteristics (T_{vj} = 25°C unless otherwise specified)

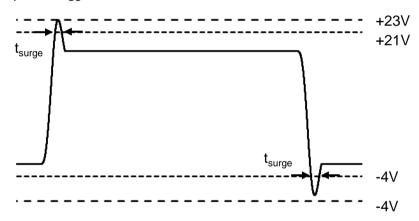
Doromotor	Symbol	Symbol Conditions -	Values			l locit
Parameter			Min.	Тур.	Max.	Unit
Transconductance	g _{fs} *8	$V_{DS} = 10V, I_{D} = 17A$	-	9.4	-	S
Input capacitance	C _{iss}	$V_{GS} = 0V$	-	1460	-	
Output capacitance	C _{oss}	V _{DS} = 500V	-	69	-	pF
Reverse transfer capacitance	C_{rss}	f = 1MHz	-	5	-	
Effective output capacitance, energy related	C _{o(er)}	$V_{GS} = 0V$ $V_{DS} = 0V$ to 500V	ı	90	-	pF
Total Gate charge	Q _g *8	$V_{DS} = 500V$ $I_{D} = 17A$	ı	63	ı	
Gate - Source charge	Q _{gs} *8	$V_{GS} = 18V$	-	14	-	nC
Gate - Drain charge	Q _{gd} *8	See Fig. 1-1, 1-2.	-	19	-	
Turn - on delay time	t _{d(on)} *8	$V_{DS} = 500V$ $I_{D} = 17A$	ı	5.1	ı	
Rise time	t _r *8	$V_{GS} = +18V / 0V$	ı	16	ı	ns
Turn - off delay time	t _{d(off)} *8	$R_G = 3.3\Omega$, L = 250µH E_{on} includes diode	ı	27	ı	115
Fall time	t _f *8	reverse recovery $L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF	-	10	-	
Turn - on switching loss	E _{on} *8	See Fig. 2-1, 2-2, 2-3.	-	112	-	1
Turn - off switching loss	E _{off} *8		<u>-</u>	17	-	μJ

●Body diode electrical characteristics (Source-Drain) (T_{vi} = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
raiailletei	Symbol	Conditions	Min.	Тур.	Max.	Offic
Forward voltage	V _{SD} *8	$V_{GS} = 0V$, $I_D = 17A$	ı	3.3	ı	V
Reverse recovery time	t _{rr} *8	$I_F = 17A$ $V_R = 500V$	ı	9.3	ı	ns
Reverse recovery charge	Q _{rr} *8	di/dt = 2900A/µs	ı	89	ı	nC
Peak reverse recovery current	: I _{rrm} *8	$L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF See Fig. 3-1, 3-2.	-	19	-	Α

^{*1} Limited by maximum T_{v_i} and assumes R_{thJC} < 1.3K/W. The value is based on TO-247 package.

*5 Example of acceptable V_{GS} waveform



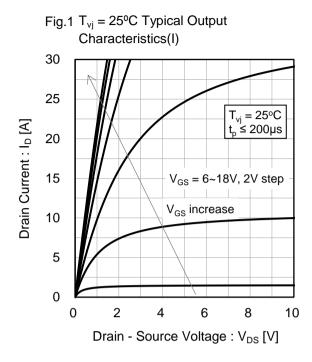
Please note especially when using driver source that $V_{\text{GSS_surge}}$ must be in the range of absolute maximum rating.

- *6 Please be advised not to use SiC-MOSFETs with V_{GS} below 10V as doing so may cause thermal runaway.
- *7 Tested after applying $V_{GS} = 21V$ for 100ms.
- *8 Pulsed

^{*2} Pulse width and duty cycle are limited by $T_{v_{i,max}}$. The value is based on TO-247 package.

^{*3} Only for body-diode, Repititive pulse, PW \leq 1.5 μ s, Duty cycle \leq 5%

^{*4} When used as a protective function, PW \leq 10 μ s



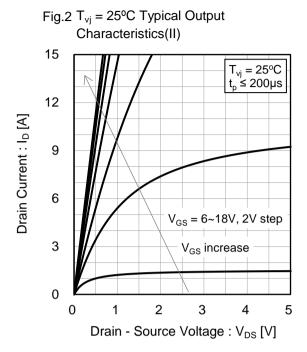
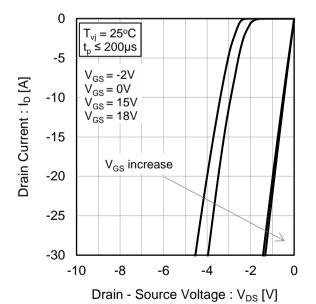
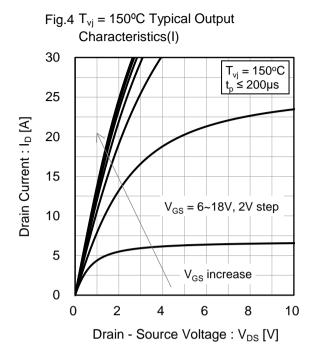
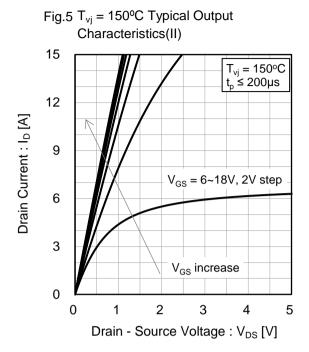
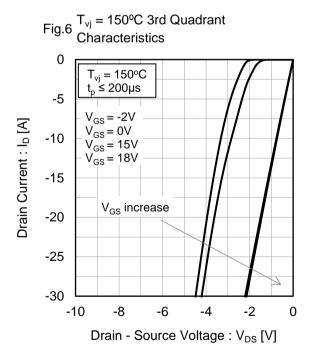


Fig.3 T_{vj} = 25°C 3rd Quadrant Characteristics









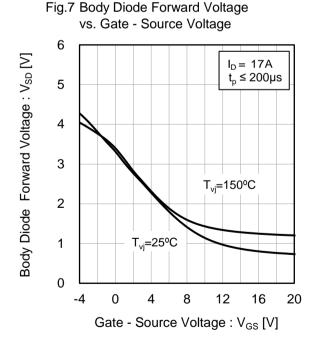


Fig.8 Typical Transfer Characteristics (I)

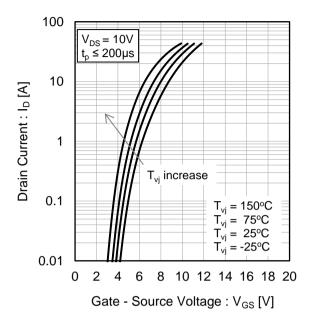


Fig.9 Typical Transfer Characteristics (II)

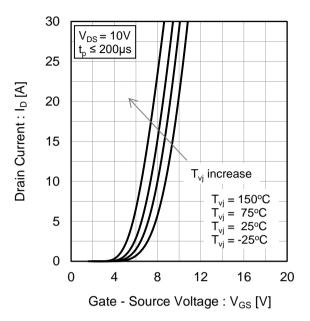


Fig.10 Gate Threshold Voltage vs. Junction Temperature

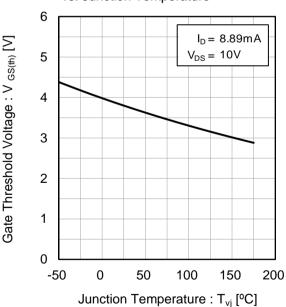
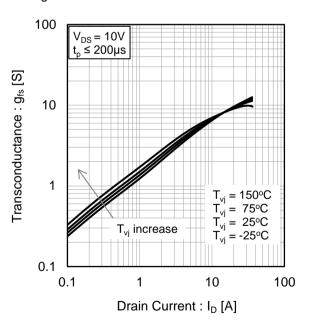
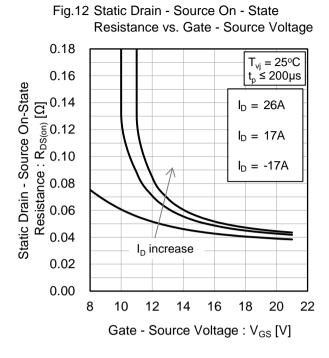


Fig.11 Transconductance vs. Drain Current





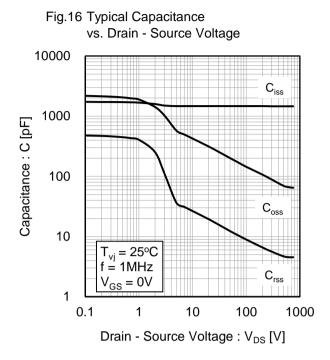
Resistance vs. Junction Temperature 0.18 $V_{GS} = 18V$ $t_p \le 200 \mu s$ 0.16 Static Drain - Source On-State Resistance : $R_{DS(00)}$ [Ω] 0.10 0.08 0.06 0.04 $I_{D} = 26A$ $I_D = 17A$ $I_D = -17A$ 0.04 I_D increase 0.02 0.00 -50 0 50 100 200 150 Junction Temperature : Tvi [°C]

Fig.13 Static Drain - Source On - State

Fig.14 Static Drain - Source On - State

ROHM

Fig.15 Normalized Drain - Source Breakdown



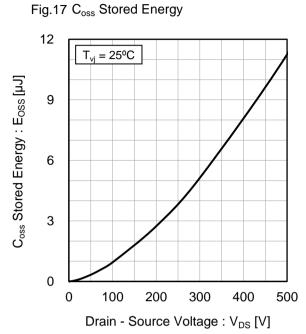


Fig.18 Dynamic Input Characteristics

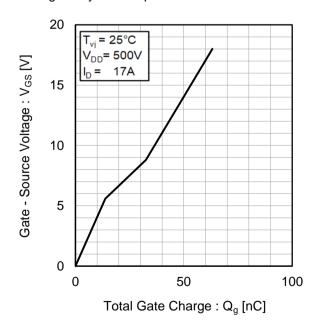


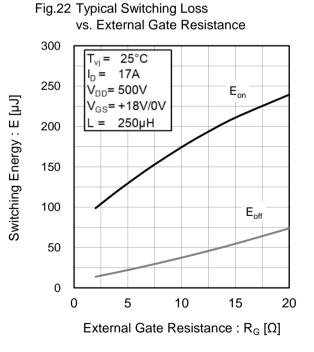
Fig.19 Typical Switching Time vs. External Gate Resistance 100 25°C 17A V_{DD}= 500V 80 V_{GS}= +18V/0V Switching Time: t [ns] $t_{d(off)}$ 250µH 60 40 20 t_f 0 5 10 15 20

External Gate Resistance : $R_G[\Omega]$

vs. Drain - Source Voltage 300 25°C 17A 250 V_{GS}= +18V/0V Switching Energy: E [µJ] $R_G = 3.3\Omega$ 250µH 200 150 100 50 $\mathsf{E}_{\mathsf{off}}$ 0 200 100 300 400 500 Drain - Source Voltage : V_{DS} [V]

Fig.20 Typical Switching Loss

Fig.21 Typical Switching Loss vs. Drain Current 300 25°C V_{DD}= 500V 250 V_{GS} = +18V/0V Switching Energy: E [µJ] $R_G = 3.3\Omega$ $L = 250 \mu H$ 200 Eon 150 100 E_{off} 50 0 0 5 10 15 25 20 30 Drain Current: I_D [A]



ROHM

•Measurement circuits and waveforms

Fig.1-1 Gate Charge Measurement Circuit

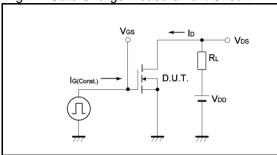


Fig.2-1 Switching Characteristics Measurement Circuit

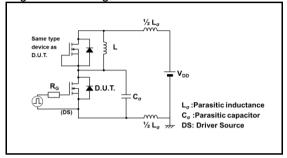


Fig.2-3 Waveforms for Switching Energy Loss

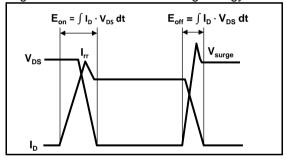


Fig.3-1 Reverse Recovery Time Measurement Circuit

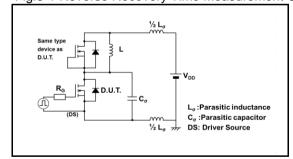


Fig.1-2 Gate Charge Waveform

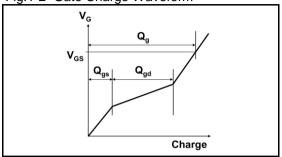


Fig.2-2 Waveforms for Switching Time

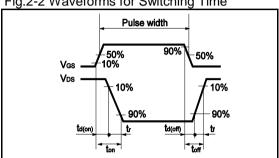
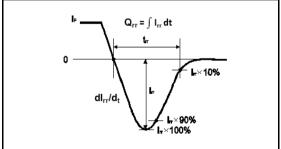


Fig.3-2 Reverse Recovery Waveform

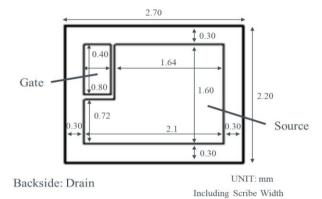


Mechanical Parameters

Die Size	2.70 mm x 2.20 mm (Including Scribe Width)	
Thickness	150 ± 15 μm	
Source Pad Size	See Pad Layout.	
Gate Pad Size	0.40 mm x 0.80 mm	

Wafer Size	150 mm
Topside Metallization	AlCu
Backside Metallization	Ti-Ni(1.2μm)-Au(0.07μm)
Passivation	Polyimide

●Pad Layout



Notes

- 1) The information contained herein is subject to change without notice.
- Before you use our Products, please contact our sales representative and verify the latest specifications.
- 3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors.

 Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM.
- 4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.
- 5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
- 6) The Products specified in this document are not designed to be radiation tolerant.
- 7) For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative: transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, and power transmission systems.
- 8) Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
- 9) ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.
- 10) ROHM has used reasonable care to ensure the accuracy of the information contained in this document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.
- 11) Please use the Products in accordance with any applicable environmental laws and regulations, such as the RoHS Directive. For more details, including RoHS compatibility, please contact a ROHM sales office. ROHM shall have no responsibility for any damages or losses resulting non-compliance with any applicable laws or regulations.
- 12) When providing our Products and technologies contained in this document to other countries, you must abide by the procedures and provisions stipulated in all applicable export laws and regulations, including without limitation the US Export Administration Regulations and the Foreign Exchange and Foreign Trade Act.
- 13) This document, in part or in whole, may not be reprinted or reproduced without prior consent of ROHM.



Thank you for your accessing to ROHM product informations.

More detail product informations and catalogs are available, please contact us.

ROHM Customer Support System

http://www.rohm.com/contact/

General Precaution

- 1. Before you use our Products, you are requested to carefully read this document and fully understand its contents. ROHM shall not be in any way responsible or liable for failure, malfunction or accident arising from the use of any ROHM's Products against warning, caution or note contained in this document.
- 2. All information contained in this document is current as of the issuing date and subject to change without any prior notice. Before purchasing or using ROHM's Products, please confirm the latest information with a ROHM sales representative.
- 3. The information contained in this document is provided on an "as is" basis and ROHM does not warrant that all information contained in this document is accurate and/or error-free. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties resulting from inaccuracy or errors of or concerning such information.

Notice – WE Rev.001